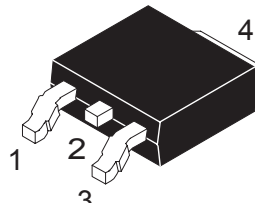
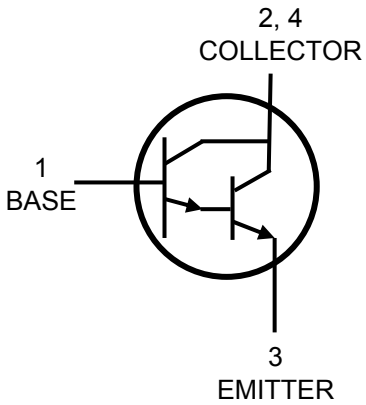


| 工业型号 | 公司型号 | 打印标识 | 封装形式 | 包装规格 |
|--------|-------|-------|--------|---------------------------------|
| MJD122 | H122G | J122G | TO-252 | 2500Pcs/卷盘, 5000Pcs/盒, 25Kpcs/箱 |

| | |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p>Designed for general purpose amplifier and low speed switching applications.</p> <p>DPAK For Surface Mount Applications Designed for general purpose amplifier and low speed switching applications.</p> <p>Features</p> <ul style="list-style-type: none"> ◆ Lead Formed for Surface Mount Applications ◆ in Plastic Sleeves ◆ Surface Mount Replacements for 2N6040–2N6045 Series TIP120–TIP122 Series, and TIP125–TIP127 Series ◆ Monolithic Construction With Built-in Base–Emitter Shunt Resistors ◆ High DC Current Gain: $hFE=2500(Typ) @ I_C=4.0A$dc ◆ Epoxy Meets UL 94 V-0 @ 0.125 in ◆ ESD Ratings: Human Body Model, $3B \geq 8000V$ Machine Model, $C \geq 400V$ ◆ Pb–Free Packages are Available <p>用于音频功率放大器</p> | <p align="center">MJD122 Series Pin Assignment</p>   |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|

ABSOLUTE MAXIMUM RATINGS (Ta=25°C , unless otherwise specified)

| SYMBOL | PARAMETER | VALUE | UNIT | |
|-----------------------------------|--------------------------------------------------|----------------------|------|------|
| Ic | Collector Current (DC) | 8 | A | |
| | Collector Current (PULSE) | 16 | | |
| I _B | Base Current | 120 | mA | |
| V _{CBO} | Collector–Emitter Voltage | 100 | V | |
| V _{CB} | Collector–Base Voltage | 100 | | |
| V _{EB} | Emitter–Base Voltage | 5 | | |
| P _D | Total Power Dissipation | T _A =25°C | 20 | W |
| | | Derate above 25°C | 0.16 | W/°C |
| T _J , T _{stg} | Operating and Storage Junction Temperature Range | -65 to +150 | °C | |
| R _{θJC} | Thermal Resistance, Junction–to–Case | 6.25 | °C/W | |
| R _{θJA} | Thermal Resistance, Junction–to–Ambient | 71.4 | | |

ELECTRICAL CHARACTERISTICS (Ta=25°C, unless otherwise specified)

| SYMBOL | CHARACTERISTICS | TEST CONDITION | MIN | MAX | UNIT |
|---------------|--------------------------------------|------------------------------------------|-------------|----------------|---------|
| I_{CEO} | Collector Cut-off Current | $V_{CE}=50V, I_B=0$ | -- | 10 | μA |
| I_{CBO} | Collector Cutoff Current | $V_{EB}=100V, I_E=0$ | -- | 10 | |
| I_{EBO} | Emitter Cut-off Current | $V_{EB}=5V, I_C=0$ | -- | 2 | mA |
| V_{CE0} | Collector-Emitter Sustaining Voltage | $I_C=30mA, I_B=0$ | 100 | | V |
| V_{CE} | Collector-Emitter Saturation Voltage | $I_C=4A, I_B=16mA$ $I_C=8A, I_B=80mA$ | | 2 4 | |
| $V_{BE(sat)}$ | Base-Emitter Saturation Voltage | $I_C=8A, V_{CE}=4V$ | | 4.5 | |
| $V_{BE(on)}$ | Base-Emitter On Voltage | $I_C=4A, V_{CE}=4V$ | | 2.8 | |
| hFE | DC Current Gain | $I_C=4A, V_C=4V$ $I_C=8A, V_C=4V$ | 1000 100 | 12000 ----- | |

DYNAMIC CHARACTERISTICS

| SYMBOL | CHARACTERISTICS | TEST CONDITION | MIN | MAX | UNIT |
|------------|--------------------------------|-----------------------------|-----|-----|------|
| $ h_{fe} $ | Current-Gain-Bandwidth Product | $I_C=3A, V_{CE}=4V, f=1MHz$ | 4 | -- | MHz |
| C_{ob} | Output Capacitance | $V_{CB}=10V, I_E=0, f=1MHz$ | -- | 200 | pF |
| h_{fe} | Small-Signal Current Gain | $I_C=3A, V_{CE}=4V, f=1MHz$ | 300 | -- | |

1. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted.

Product performance may not be indicated by the Electrical Characteristics if operated under different conditions

2. Pulse Test: Pulse Width 300 s, Duty Cycle 2%.

TYPICAL ELECTRICAL CHARACTERISTICS

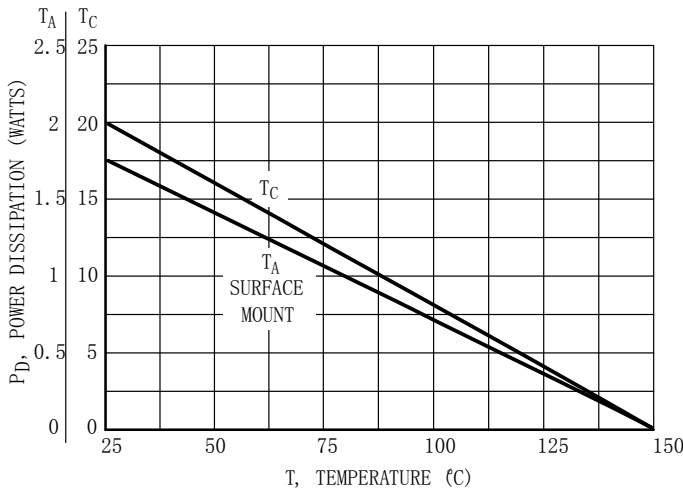


Figure 1. Power Derating

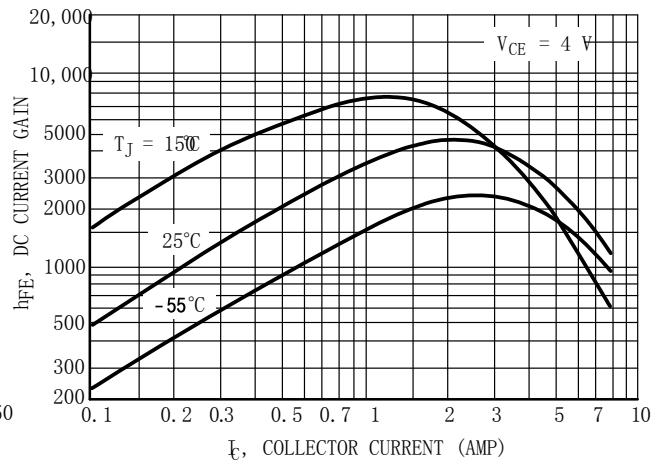


Figure 2. DC Current Gain

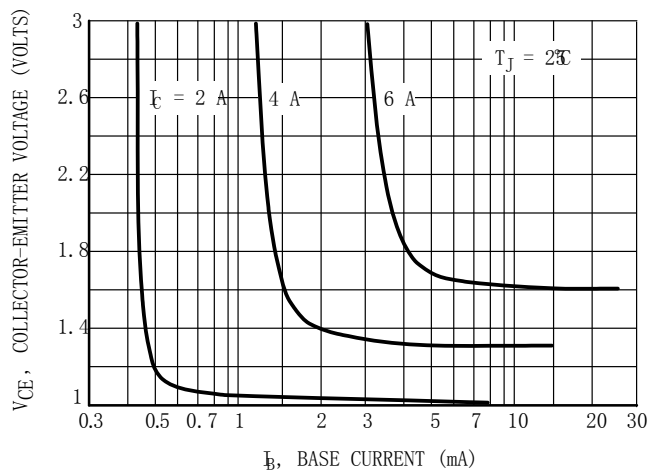
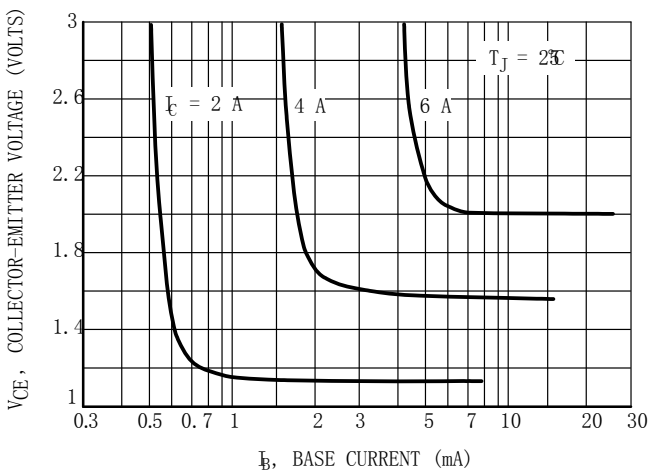


Figure 3. Collector Saturation Region

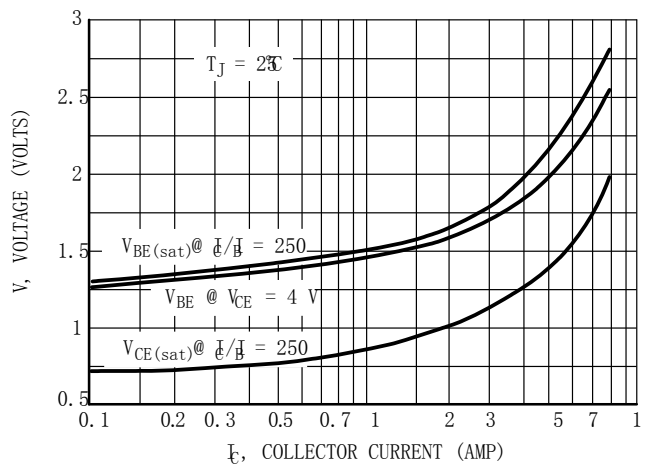
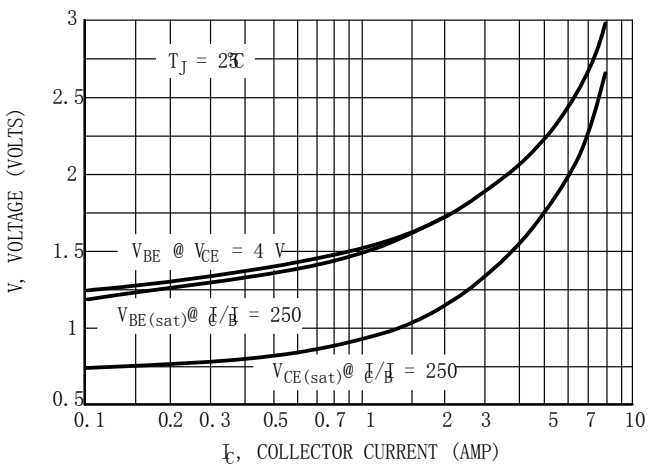


Figure 4. "On" Voltages

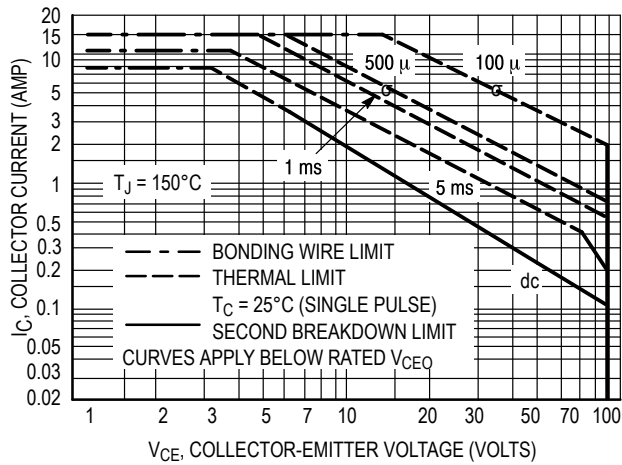


Figure 5. Maximum Forward Bias Safe Operating Area

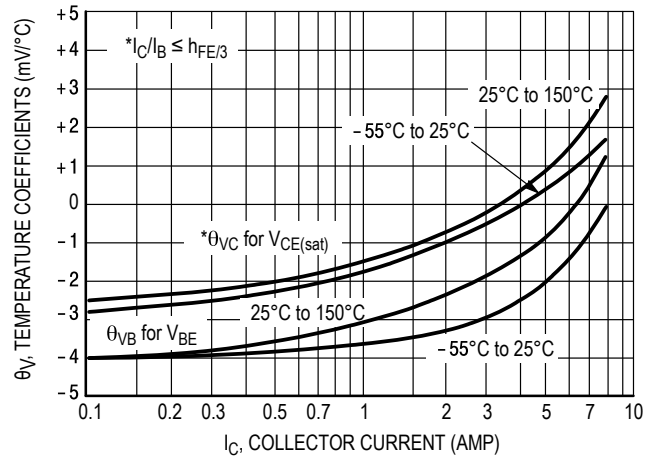


Figure 6. Temperature Coefficients

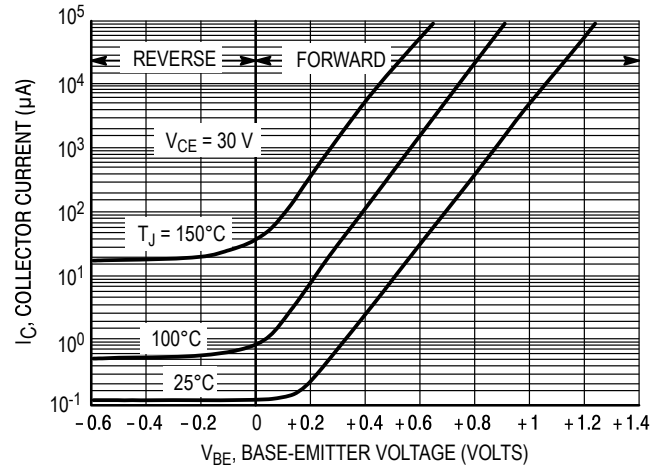
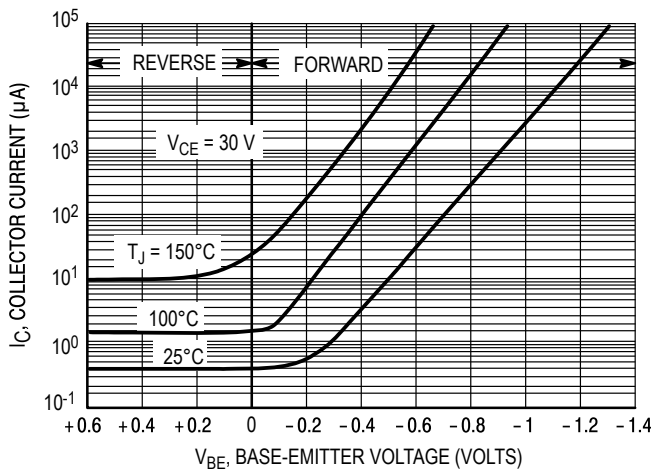


Figure 7. Collector Cut-Off Region

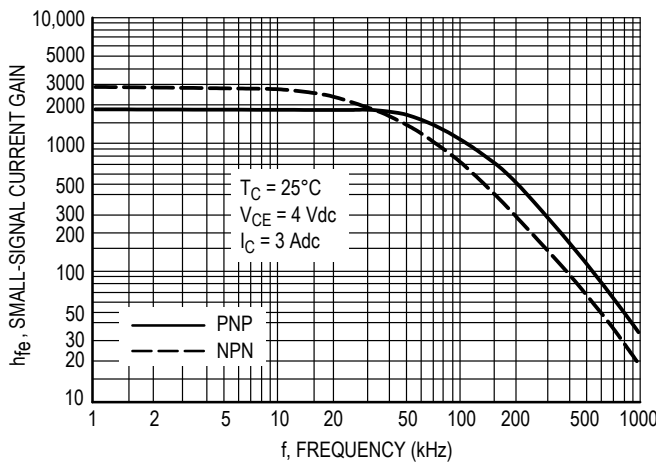


Figure 8. Small-Signal Current Gain

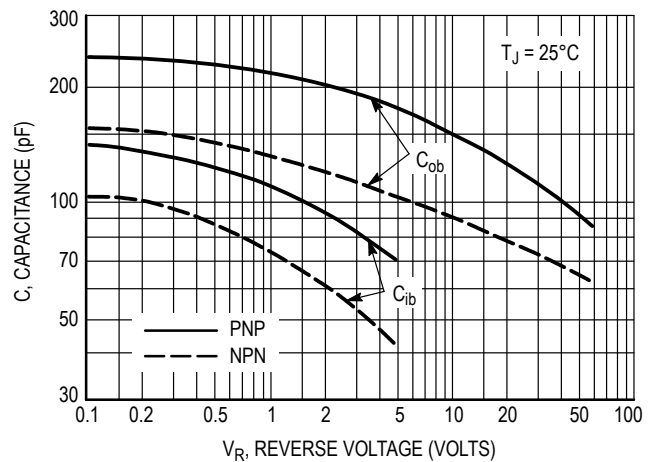


Figure 9. Capacitance

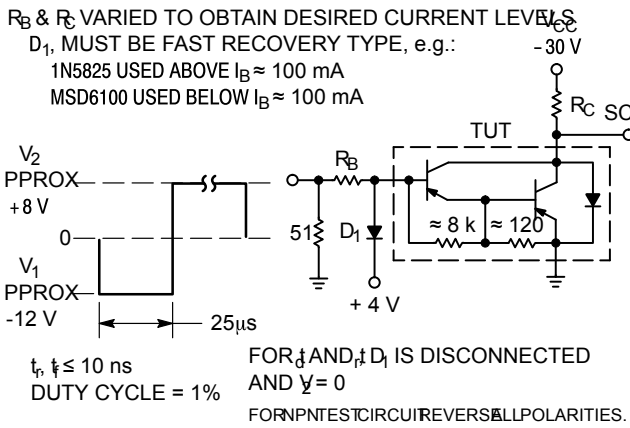


Figure 10. Switching Times Test Circuit

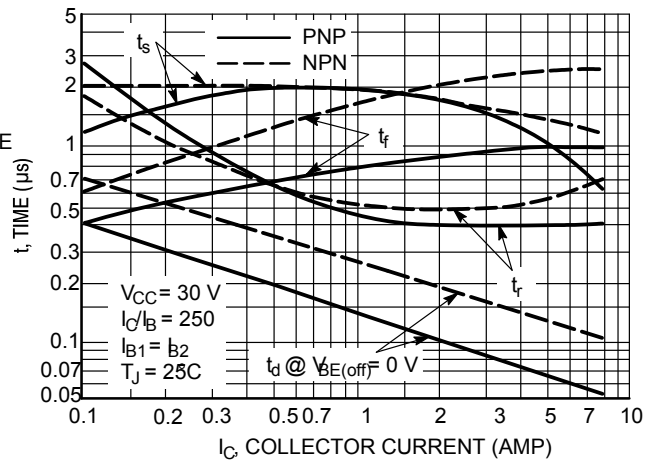


Figure 11. Switching Times

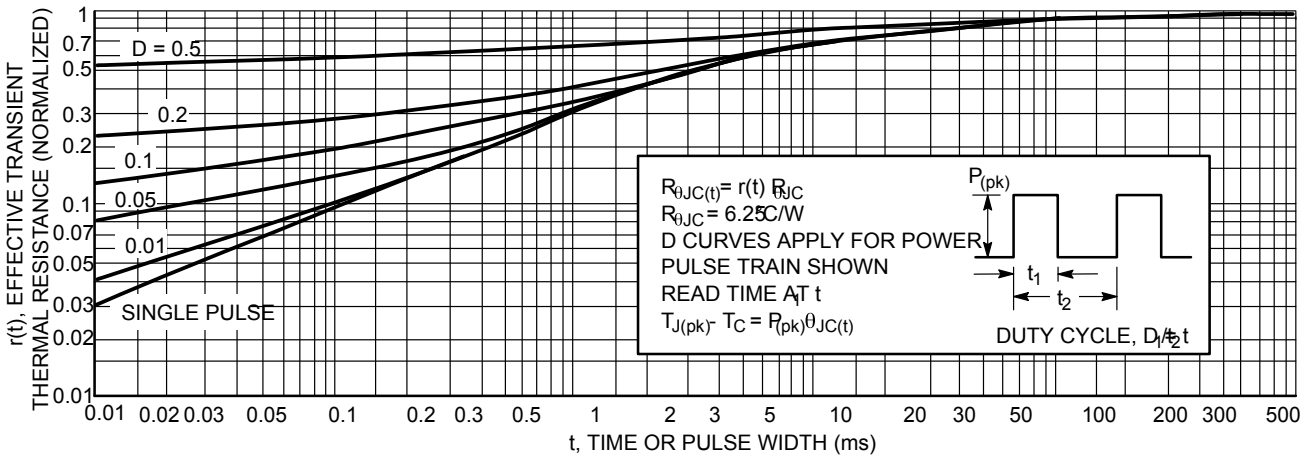


Figure 13. Thermal Response

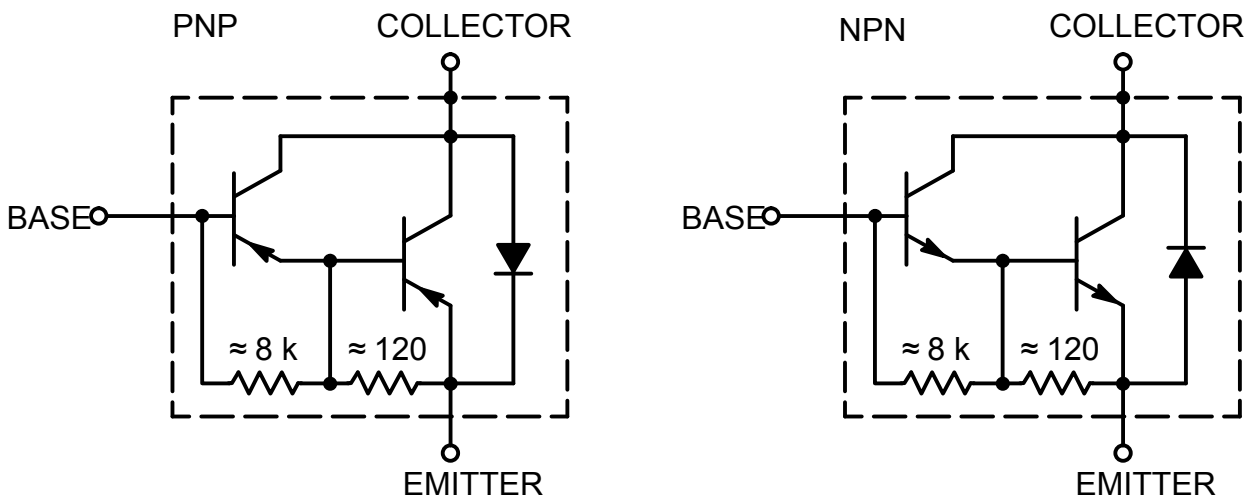
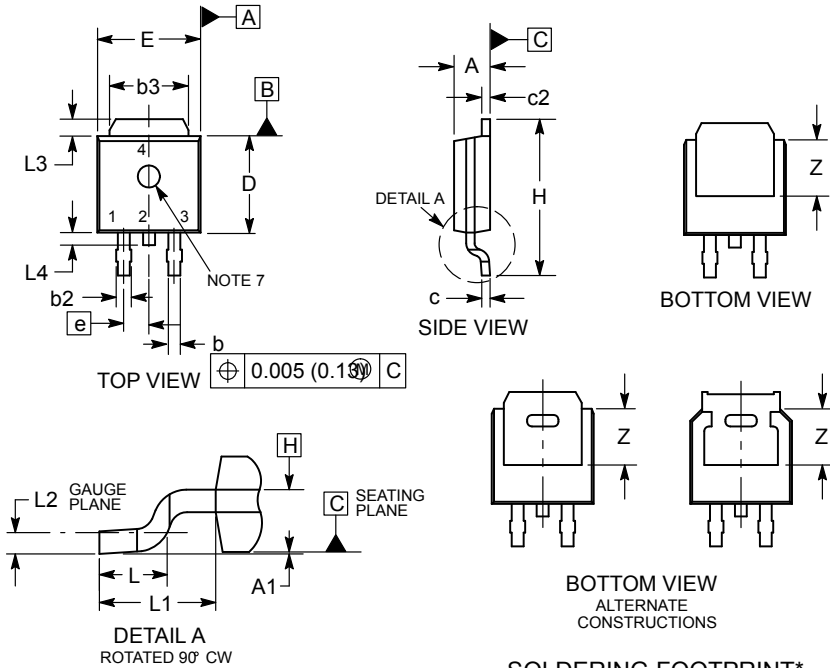


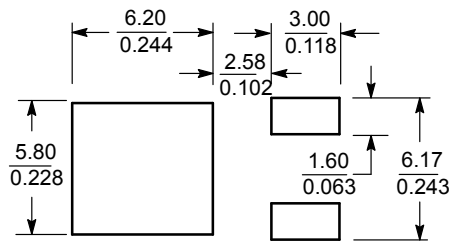
Figure 14. Darlington Schematic

PACKAGE DIMENSIONS (mm)



| DIM | INCHES | | MILLIMETERS | |
|-----|-----------|-------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.086 | 0.094 | 2.18 | 2.38 |
| A1 | 0.000 | 0.005 | 0.00 | 0.13 |
| b | 0.025 | 0.035 | 0.63 | 0.89 |
| b2 | 0.028 | 0.045 | 0.72 | 1.14 |
| b3 | 0.180 | 0.215 | 4.57 | 5.46 |
| c | 0.018 | 0.024 | 0.46 | 0.61 |
| c2 | 0.018 | 0.024 | 0.46 | 0.61 |
| D | 0.235 | 0.245 | 5.97 | 6.22 |
| E | 0.250 | 0.265 | 6.35 | 6.73 |
| e | 0.090 BSC | | 2.29 BSC | |
| H | 0.370 | 0.410 | 9.40 | 10.41 |
| L | 0.055 | 0.070 | 1.40 | 1.78 |
| L1 | 0.114 REF | | 2.90 REF | |
| L2 | 0.020 BSC | | 0.51 BSC | |
| L3 | 0.035 | 0.050 | 0.89 | 1.27 |
| L4 | --- | 0.040 | --- | 1.01 |
| Z | 0.155 | --- | 3.93 | --- |

SOLDERING FOOTPRINT*



SCALE 3:1 (mm/inches)

STYLE 1:

PIN 1. BASE

2. COLLECTOR

3. EMITTER

4. COLLECTOR

Manufacturers version information

2007-03-11, HAOHAI™ Product Data-S1.0

2010-04-10, HAOHAI™ Product Data-S1.1

2014-07-11, HAOHAI™ Product Data-S2.0

2018-10-23, HAOHAI™ Product Data-S2.1

2021-06-04, HAOHAI™ Product Data-S2.2



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